Product Preview

Self-Protected Low Side Driver with Temperature and Current Limit

42 V, 14 A, Single N-Channel, SOT-223

NCV8403 is a three terminal protected Low-Side Smart Discrete device. The protection features include overcurrent, overtemperature, ESD and integrated Drain-to-Gate clamping for overvoltage protection. This device offers protection and is suitable for harsh automotive environments. There is a fault feedback feature by monitoring the input current at the gate or voltage if a resistor is utilized.

Features

- Short Circuit Protection
- Thermal Shutdown with Automatic Restart
- Over Voltage Protection
- Integrated Clamp for Inductive Switching
- ESD Protection
- dV/dt Robustness
- Analog Drive Capability (Logic Level Input)
- RoHs Compliant
- AEC-Q101 Qualified
- NCV Prefix for Automotive and Other Applications Requiring Site and Change Control
- This is a Pb-Free Device

Typical Applications

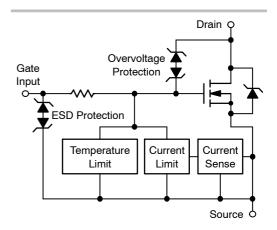
- Switch a Variety of Resistive, Inductive and Capacitive Loads
- Can Replace Electromechanical Relays and Discrete Circuits
- Automotive / Industrial



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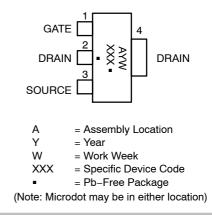
http://onsemi.com

V _{DSS} (Clamped)	R _{DS(on)} TYP	I _D MAX (Limited)
42 V	53 m Ω @ 10 V	15 A





MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Rating	Symbol	Value	Unit	
Drain-to-Source Voltage Internally Clamped	V _{DSS}	42	Vdc	
Gate-to-Source Voltage	V _{GS}	±14	Vdc	
Drain Current Continuous	Ι _D	Internally Limited		
Total Power Dissipation @ $T_A = 25^{\circ}C$ (Note 1) @ $T_A = 25^{\circ}C$ (Note 2)	P _D	1.25 1.9	W	
Thermal Resistance Junction-to-Case Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2)	$f R_{ heta JC} \ R_{ heta JA} \ R_{ heta JA}$	12 100 65	°C/W	
Single Pulse Drain-to-Source Avalanche Energy $(V_{DD} = 25 \text{ Vdc}, V_{GS} = 5.0 \text{ Vdc}, I_L = 7.0 \text{ Apk}, L = 9.5 \text{ mH}, R_G = 25 \Omega)$	E _{AS}	233	mJ	
Operating and Storage Temperature Range (Note 3)	T _J , T _{stg}	-55 to 150	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Surface mounted onto minimum pad size (0.412" square) FR4 PCB, 1 oz cu.
Mounted onto 1" square pad size (1.127" square) FR4 PCB, 1 oz cu.
Normal pre-fault operating range. See thermal limit range conditions.

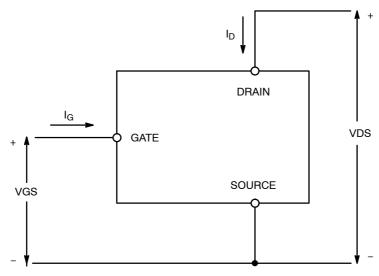
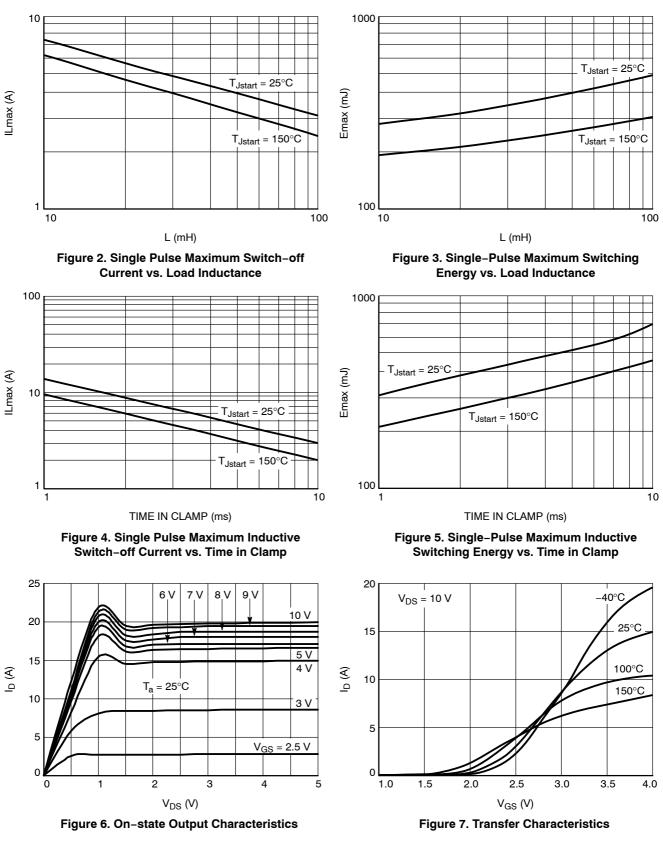


Figure 1. Voltage and Current Convention

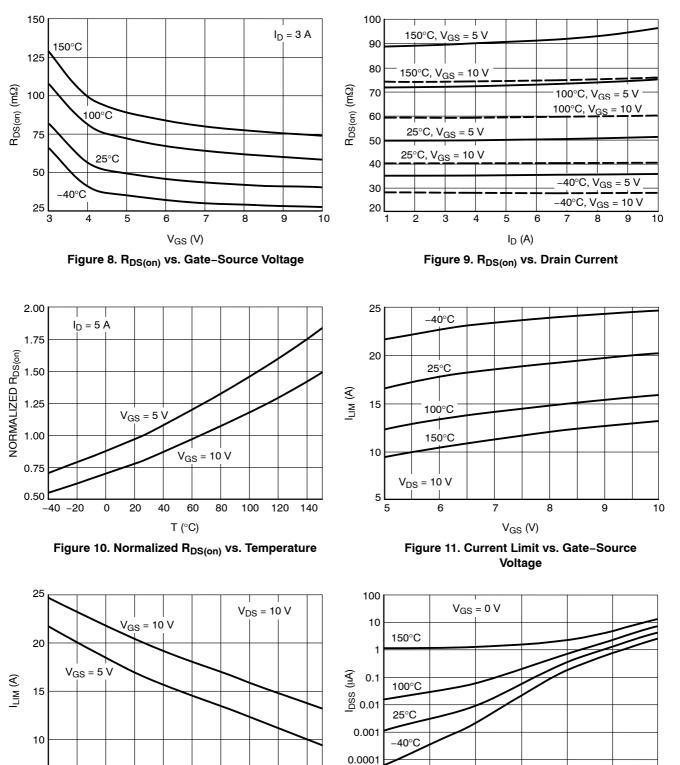
Characte	Symbol	Min	Тур	Max	Unit		
OFF CHARACTERISTICS							
Drain-to-Source Clamped Breakdown Vol	tage	V _{(BR)DSS}	40	40	F 4	Vala	
(V _{GS} = 0 Vdc, I _D = 250 μAdc) (V _{GS} = 0 Vdc, I _D = 250 μAdc, T _J = -40°		42 40	46 45	51 51	Vdc Vdc		
Zero Gate Voltage Drain Current (V _{DS} = 32 Vdc, V _{GS} = 0 Vdc)	I _{DSS}	-	0.6	5.0	μAdc		
$(V_{DS} = 32 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}, T_{J} = 150^{\circ}$		-	2.5	-			
Gate Input Current (V _{GS} = 5.0 Vdc, V _{DS} = 0 Vdc)	I _{GSS}	-	50	125	μAdc		
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(th)}					
(V _{DS} = V _{GS} , I _D = 1.2 mAdc) Threshold Temperature Coefficient (Ne	gative)		1.0 _	1.7 5.0	2.2	Vdc mV/°C	
Static Drain-to-Source On-Resistance (N	ote 5)	R _{DS(on)}				mΩ	
$(V_{GS} = 10 \text{ Vdc}, I_D = 3.0 \text{ Adc}, T_J @ 25^{\circ}(V_{GS} = 10 \text{ Vdc}, I_D = 3.0 \text{ Adc}, T_J @ 150^{\circ})$		-	53 95	68 123			
Static Drain-to-Source On-Resistance (N		R _{DS(on)}				mΩ	
$(V_{GS} = 5.0 \text{ Vdc}, I_D = 3.0 \text{ Adc}, T_J @ 25^{\circ})$ $(V_{GS} = 5.0 \text{ Vdc}, I_D = 3.0 \text{ Adc}, T_J @ 150^{\circ})$	()	-	63 105	76 135			
Source–Drain Forward On Voltage $(I_S = 7.0 \text{ A}, V_{GS} = 0 \text{ V})$	V _{SD}	-	0.95	1.1	V		
SWITCHING CHARACTERISTICS (Note 4	4)						
Turn–ON Time (10% V_{IN} to 90% $I_{\text{D}})$	V _{IN} = 0 V to 5 V, V _{DD} = 25 V	t _{ON}		44		μs	
Turn–OFF Time (90% V_{IN} to 10% $I_{\text{D}})$	$I_D = 1.0 \text{ A}, \text{ Ext } R_G = 2.5 \Omega$	t _{OFF}		84			
Turn–ON Time (10% V_{IN} to 90% $I_{\text{D}})$	V _{IN} = 0 V to 10 V, V _{DD} = 25 V	t _{ON}		15			
Turn–OFF Time (90% V_{IN} to 10% $I_{\text{D}})$	$I_D = 1.0 \text{ A}, \text{ Ext } R_G = 2.5 \Omega$	t _{OFF}		116			
Slew-Rate ON (20% V_{DS} to 50% $V_{DS})$	V _{in} = 0 to 10 V, V _{DD} = 12 V,	-dV _{DS} /dt _{ON}		2.43		V/μs	
Slew-Rate OFF (80% V _{DS} to 50% V _{DS}) $R_L = 4.7 \Omega$		dV _{DS} /dt _{OFF}		0.83			
SELF PROTECTION CHARACTERISTICS	$(T_J = 25^{\circ}C \text{ unless otherwise noted})$ (N	lote 6)			_		
Current Limit	V_{GS} = 5.0 V, V_{DS} = 10 V V_{GS} = 5.0 V, T_J = 150°C (Note 4)	I _{LIM}	10 5.0	15 10	20 15	Adc	
Current Limit	V _{GS} = 10 V, V _{DS} = 10 V V _{GS} = 10 V, T _J = 150°C (Note 4)	I _{LIM}	12 8.0	17 13	22 18	Adc	
Temperature Limit (Turn-off)	V_{GS} = 5.0 Vdc	T _{LIM(off)}	150	175	200	°C	
Thermal Hysteresis	$V_{GS} = 5.0 \text{ Vdc}$	$\Delta T_{LIM(on)}$	-	15	-	°C	
Temperature Limit (Turn-off)	V _{GS} = 10 Vdc	T _{LIM(off)}	150	165	185	°C	
Thermal Hysteresis	V _{GS} = 10 Vdc	$\Delta T_{LIM(on)}$	-	15	-	°C	
GATE INPUT AND FAULT DIAGNOSTICS	CHARACTERISTICS (Note 4)						
Device ON Gate Input Current	$V_{GS} = 5 V I_D = 1.0 A$	I _{GON}		50		μA	
	V _{GS} = 10 V I _D = 1.0 A			400			
Current Limit Gate Input Current	$V_{GS} = 5 \text{ V}, V_{DS} = 10 \text{ V}$	I _{GCL}		0.1		mA	
	V_{GS} = 10 V, V_{DS} = 10 V			0.6			
Thermal Limit Fault Gate Input Current	V_{GS} = 5 V, V_{DS} = 10 V	I _{GTL}		0.45		mA	
	V_{GS} = 10 V, V_{DS} = 10 V			1.5			
ESD ELECTRICAL CHARACTERISTICS	$(T_J = 25^{\circ}C \text{ unless otherwise noted})$						
Electro-Static Discharge Capability	Human Body Model (HBM)	ESD	4000	-	-	V	
Electro-Static Discharge Capability Machine Model (MM)		ESD	400	l		V	

4. Not subject to production testing.
5. Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2%.
6. Fault conditions are viewed as beyond the normal operating range of the part.

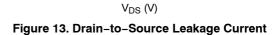




TYPICAL PERFORMANCE CURVES

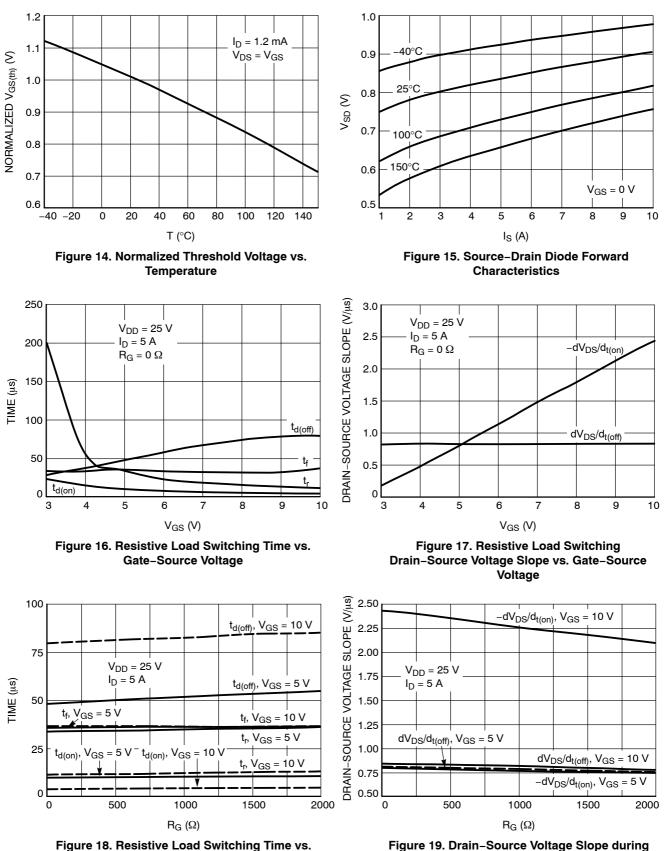


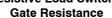
5 40 -20

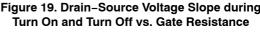


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TYPICAL PERFORMANCE CURVES



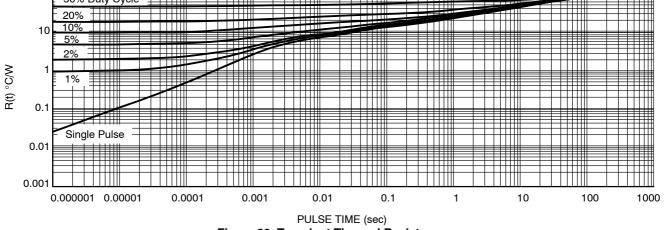




50% Duty Cycle

100







TEST CIRCUITS AND WAVEFORMS

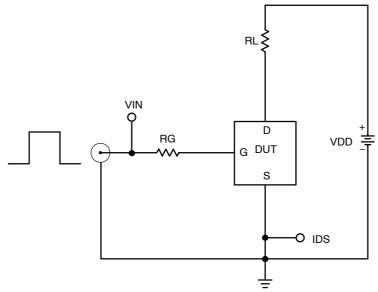


Figure 21. Resistive Load Switching Test Circuit

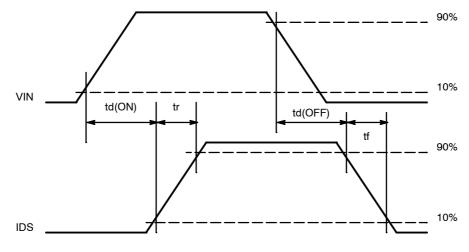


Figure 22. Resistive Load Switching Waveforms

TEST CIRCUITS AND WAVEFORMS

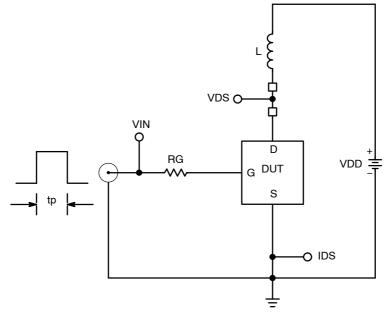


Figure 23. Inductive Load Switching Test Circuit

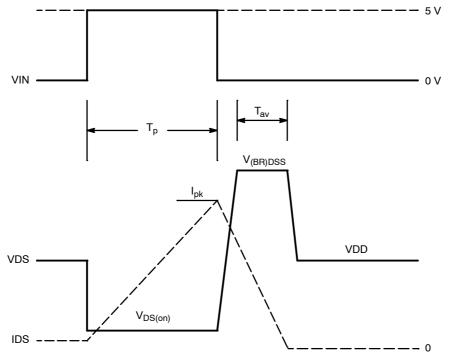


Figure 24. Inductive Load Switching Waveforms

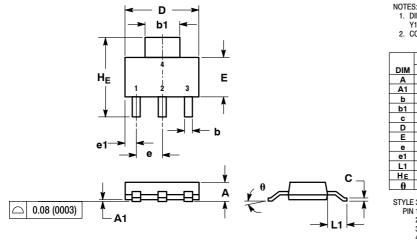
ORDERING INFORMATION

Device	Package	Shipping [†]
NCV8403	SOT-223 (Pb-Free)	1000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 ISSUE M



1. DIMENSIONING AND TOLERANCING PER ANSI

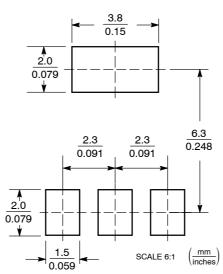
Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.50	1.63	1.75	0.060	0.064	0.068
A1	0.02	0.06	0.10	0.001	0.002	0.004
b	0.60	0.75	0.89	0.024	0.030	0.035
b1	2.90	3.06	3.20	0.115	0.121	0.126
с	0.24	0.29	0.35	0.009	0.012	0.014
D	6.30	6.50	6.70	0.249	0.256	0.263
Е	3.30	3.50	3.70	0.130	0.138	0.145
e	2.20	2.30	2.40	0.087	0.091	0.094
e1	0.85	0.94	1.05	0.033	0.037	0.041
L1	1.50	1.75	2.00	0.060	0.069	0.078
HE	6.70	7.00	7.30	0.264	0.276	0.287
θ	0°	-	10°	0°	-	10°



SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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